



NOTES:
 1. MATERIAL:
 HOUSING: LCP, BLACK, UV 94V-0
 TERMINAL: COPPER ALLOY, T=0.15mm
 PEG: STAINLESS STEEL, T=0.20mm
 2. FINISH:
 TERMINAL: 50u" MIN NI UNDERPLATING, OVERALL
 GOLD FLASH ON CONTACT AREA
 TIN 60-200u" PLATING ON SOLDER AREA
 PEG: 50u" MIN NI UNDERPLATING OVERALL
 TIN 60-200u" PLATING ON SOLDER AREA

JYS-BY450-085	4.50	3.25	3.75	3.90
JYS-BY400-084	4.00	2.75	3.25	3.40
JYS-BY350-083	3.50	2.25	2.75	2.90
P/N	DIM A	DIM B	DIM C	DIM D

GENERAL TOLERANCE		DWG NO.	JYSA0918-004	APPD:	WMD	Scale	1:1
X.±0.45	X.±5°	Title	BATTERY 3PIN 3.0PITCH	CHKD:		UNIT	mm
X±0.35	X.±2°		3.5H-4.5H 侧压 中间柱	DR:			
XX±0.25	.XX±1°	Part NO.	SEE TABLE	Date	2013/05/29		
.XXX±0.15	.xxx±0.5°						
SHEET	1/1						

JYS 杰宇森电子有限公司
 JIE YU SEN ELECTRONIC CO., LTD.

REV.	ECH. NO.	MODIFY. CONTENT	DATE
A		NEW	2011/10/31